Open-Minded

Influence of Defects and Charge Transfer from the Substrate on the Surface Potential of Graphene

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Goals

- Investigation and quantitative characterisation of energy dissipation processes during and after energetic ion
- Tailoring of morphological and physical properties of 2D materials (e.g. graphene MoS₂, Mica) [2,3,4]
- In situ study of 2D FETs using AFM techniques, e.a. KPFM, cAFM



Experiment

- Irradiation experiments at the IRRSUD beamline of the GANIL (Caen, France) and at the M1 branch at the GSI (Darmstadt, Germany)
- · Sample characterisation in ambient with tapping mode AFM and Raman spectroscopy
- UHV measurements with non-contact AFM and Kelvin probe force microscopy



Sample Preparation

· Samples are prepared using the mechanical exfoliation technique (or Scotch Tape methode). This technique can be applied on any layered material resulting in 2D crystals of the highest quality.

Graphene on thin Au/Ti films

. In situ mechanical exfoliation of graphene on arbitrary, well defined substrates [5]

Physical Vapour Deposition used to

Goal: Employ Ti diffusion in gold -

triggered by sample heating [8] to

precisely tune the WF of graphene

· Graphene is exfoliated in ambient and

irradiated with swift heavy ions under

glancing incidence creating origami like foldings, allowing SLG identification [9]

. In situ non-contact AFM show foldings on SLG and BLG

SiO./Si substrates

grow thin films of Au/ Ti on standard



Tuning the Work Function of Graphene by Defects, Adsorbates & Substrate

In situ heating of graphene on mica

- Graphene exfoliated in ambient shows intercalated water layers (ICW)
- · Surface potential is decreasing with increasing layer thickness
- Annealing in situ (180 °C) removes ICW islands and fractals at the graphene edge
- Fractals exhibits an increased SP substrate charge transfer is effectively blocked by ICW [6]
- Heating to 600 °C increases the size of the fractals, vet ICW cannot be completely removed
- Surface potential is now decreasing with layer thickness - n-type











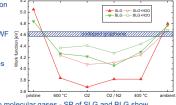






Tuning of the work function with adsorbates

- Quantitative KPFM for work function (WF) analysis - FLG is used to calibrate the WF of the tip [7]
- · Pristine graphene on mica has a WF of 5.09 eV (4.57 eV for undoped SLG) -> p-type doped
- In situ heating to 600 °C decreases the WF to 3.90 eV -> transition to n-type doping



- . Exposure of defective graphene to molecular gases SP of SLG and BLG show
- Ambient exposure leads to a SP contrast inversion again. Thus any values measured







being on top of graphene.

-0.3 V -300 -250 -200 -150 -100

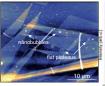
• These findings show the necessity of controlled sample preparation conditions. Using in situ e-beam evaporation and exfoliation, this experiment will be repeated

• Surface potential distribution indicates p-type doping of graphene. However the

adsorbate layer is not blocking the charge transfer, which might be due to adsorbates

Defects in graphene created by nanobubbles

- · Origin of the n-type doping is investigated in ambient by tapping mode AFM & Raman spectroscopy
- AFM scans reveal two new structures on
- Nanobubbles with a height up to 15 nm
- Flat plateaus with a constant height of
- Raman spectroscopy of SLG shows formation of very prominent disorder induced D-peak by heating
- Raman mapping of D-peak intensity Intensity generally decreases with increasing layer thickness, yet flat plateaus show a strongly increased defect density.

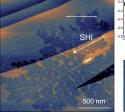






Water intercalated few laver graphene

- · Exfoliated FLG often used to calibrate the WF of the AFM tip - influence of ICW is
- Swift heavy ion irradiation under glancing incidence employed to fabricate a channel in which mild heating causes water desorption
- No SP contrast between FLG and FLG+ICW is observed







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